

ML4002-56

Technical Reference

MSA Compliant 56G
QSFP Electrical Passive Loopback Module



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ML4002-56 QSFP 4x56G Passive Loopback Modules | Key Features

- Power Consumption of 5 W
- Operation up to 56G per lane
- Dual LED indicator
- Custom Memory Maps
- 100% at rate AC testing, on each unit
- Temperature range from 0° to 80° C
- MSA Compliant Memory Map
- High performance signal integrity traces
- Temperature Monitoring
- Voltage Monitoring
- Insertion Counter
- Power Staging
- Hot pluggable module
- Micro controller based

LED Indicator

Green (Solid) - Signifies that the module is operating in high power mode.

Amber (Solid) - Signifies the module is operating in low power mode.

Green / Amber (Blinking) - Signifies that the module is overheated and the temperature high alarm is asserted.

Operating Conditions

Recommended Operating Conditions						
Parameter	Symbol	Notes/Conditions	Min	Typ	Max	Units
Operating Temperature	T _A		0		80	°C
Supply Voltage	VCC	Main Supply Voltage	3.00	3.3	3.5	V
Data Rate	R _b	Guaranteed to work at 56 Gbps per lane	0		200	Gbps
Input/Output Load Resistance	RL	AC-Coupled, Differential	90	100	110	Ω
Power Class		Programmable to Emulate all power classes	0		5	W

1. General Description

The **ML4002-56** is a QSFP56 passive electrical loopback module which is a hot pluggable form factor designed for high speed testing application for QSFP host ports. The **ML4002-56** is designed for 100 Gigabit Ethernet applications and provides 4x56G RX and TX lanes, I2C module management interface and all the QSFP SFF hardware signals.

The **ML4002-56** loops back 4-lane 56 Gb/s transmit data from the Host back to 4-lane 56 Gb/s receive data port to the Host.

The **ML4002-56** provides programmable power dissipation up to 5 W allowing the module to emulate all the QSFP56 power classes. It also provides a voltage sense, an insertion counter, a power staging, a LED blinking rate, an upper temperature cut off and a temperature sensor.

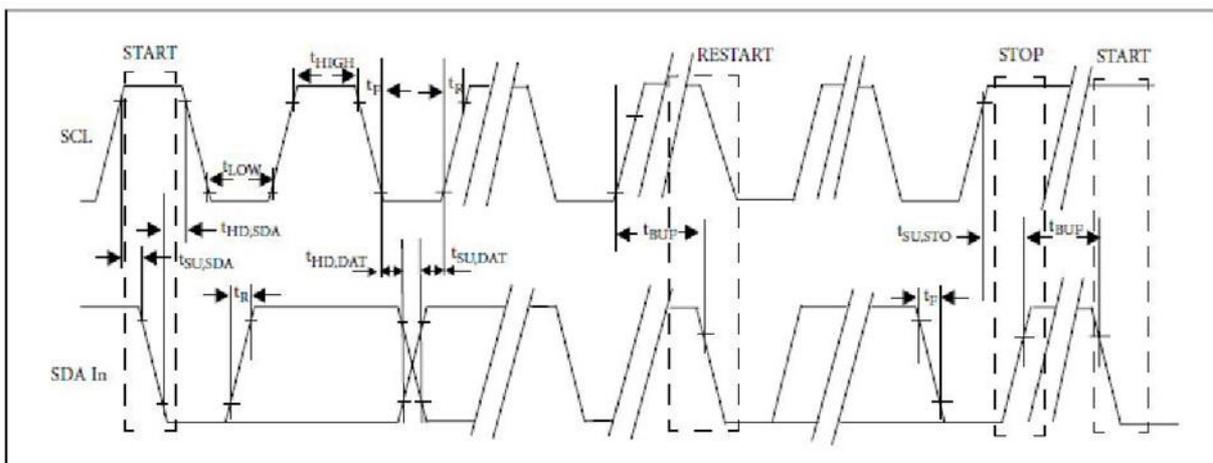
2. Functional Description

2.1 Management Data Interface – I2C

The **ML4002-56** supports the I2C interface. This QSFP+ specification is based on the SFF8436 specification. Address 128 Page00 is used to indicate the use of the QSFP+ memory map rather than the QSFP memory map.

2.2 I2C Signals, Addressing and Frame Structure

I2C Frame:



Before initiating a 2-wire serial bus communication, the host shall provide setup time on the ModSel line of all modules on the 2-wire bus. The host should not change the ModSel line of any module until the 2-wire serial bus communication is complete and the hold time requirement is satisfied. The 2-wire serial interface address of the QSFP+ module is 1010000X (A0h). In order to allow access to multiple QSFP+ modules on the same 2-wire serial bus, the QSFP+ pinout includes a ModSel or module select pin. This pin (which is pulled high or deselected in the module) must be held low by the host to select the module of interest and allow communication

over the 2-wire serial interface. The module will not respond to or accept 2-wire serial bus instructions unless it is selected.

Parameter	Symbol	Min	Max	Unit
Clock Frequency	f_{SCL}	30	400	kHz
Clock Pulse Width Low	t_{LOW}	1.2		us
Clock Pulse Width High	t_{High}	1.1		us
Time bus free before new transmission can start	t_{BUF}	20.8		us
Input Rise Time (400 kHz)	$t_{R,400}$	300		ns
Input Fall Time (400 kHz)	$t_{F,400}$	300		ns
ModSel Setup Time	Host_select_setup	2		ms
ModSel Hold Time	Host_select_hold	10		us
Serial Interface Clock Holdoff "Clock Stretching"	T_clock_hold		500	us

Maximum time the QSFP56 Module may hold the SCL line low before continuing with a read or write operation is 500 us.

2.2.1 Device Addressing and Operation

Serial Clock (SCL): The host supplying SCL input to QSFP transceivers is used to positive-edge clock data into each QSFP+ device and negative-edge clock data out of each device.

Serial Data (SDA): The SDA pin is bi-directional for serial data transfer. This pin is open-drain or open-collector driven.

Master/Slave: QSFP transceivers operate only as slave devices. The host must provide a bus master for SCL and initiate all read/write communication.

Device Address: Each QSFP is hard wired at the device address A0h.

Multiple Devices per SCL/SDA: While QSFP transceivers are compatible with point-to-point SCL/SDA, they can share a single SCL/SDA bus by using the QSFP ModSel line.

Clock and Data Transitions: The SDA pin is normally pulled high with an external device. Data on the SDA pin may change only during SCL low time periods. Data changes during SCL high periods indicate a START or STOP condition. All addresses and data words are serially transmitted to and from the QSFP in 8-bit words. Every byte on the SDA line must be 8-bits long. Data is transferred with the most significant bit (MSB) first.

START Condition: A high-to-low transition of SDA with SCL high is a START condition, which must precede any other command.

STOP Condition: A low-to-high transition of SDA with SCL high is a STOP condition.

Acknowledge: After sending each 8-bit word, the transmitter releases the SDA line for one-bit time, during which the receiver is allowed to pull SDA low (zero) to acknowledge (ACK) that it has received each word. Device address bytes and write data bytes initiated by the host shall be acknowledged by QSFP transceivers. Read data bytes transmitted by QSFP transceivers shall be acknowledged by the host for all but the final byte read, for which the host shall respond with a STOP instead of an ACK.

Memory (Management Interface) Reset: After an interruption in protocol, power loss or system reset the QSFP management interface can be reset. Memory reset is intended only to reset the QSFP transceiver management interface (to correct a hung bus). No other transceiver functionality is implied.

1. Clock up to 9 cycles
2. Look for SDA high in each cycle while SCL is high
3. Create a Start condition as SDA is high

Device Addressing: QSFP devices require an 8-bit device address word following a start condition to enable a read or write operation. The device address word consists of a mandatory sequence for the first seven most significant bits in Figure 1. This is common to all QSFP devices.

	1	0	1	0	0	0	0	R/W
MSB								LSB

Figure 1: QSFP+ Device Address

The eighth bit of the device address is the read/write operating select bit. A read operation is initiated if this bit is set high and a write operation is initiated if this bit is set low. Upon compare of the device address (with ModSelL in the low state) the QSFP transceiver shall output a zero (ACK) on the SDA line to acknowledge the address.

2.3 I2C Read/Write Functionality

2.3.1 QSFP+ Memory Address Counter (Read AND Write Operations)

QSFP+ devices maintain an internal data word address counter containing the last address accessed during the latest read or write operation, incremented by one. The address counter is incremented whenever a data word is received or sent by the module. This address stays valid between operations as long as QSFP+ power is maintained. The address “roll over” during read and writes operations is from the last byte of the 128-byte memory page to the first byte of the same page.

2.4.3 LPMODE

The Module will be in low power mode if the LPMODE pin is in the high state, or if the Power_override bit is in the high state and the Power_set bit is also high. The module will be in high power mode if the LPMODE pin is in the low state, or the Power_override bit is high and the Power_set bit is low. Note that the default state for the Power_override bit is low.

In low power mode, module will stop all power dissipation and LED changes color to amber, in high power mode the power dissipation will be set to value written inside register 98 and LED will be green.

For testing purpose LPMODE pin state can be read via register address 146 of memory page 2. The data read from address 146 will reflect the hardware signal level (1 if LPMODE is high and 0 if low).

Address	Bit	Name	Description
93(Lower Page)	0	Power_override	Power set to low power mode. Default 0.
	1	Power_set	Override of LPMODE signal setting the power mode with software.

A truth table for the relevant configurations of the LPMODE and the Power_override and Power_set are shown in the table below:

LPMODE	Power_override	Power_set	Module Power State 1
1	0	X	Low Power
0	0	X	High Power
X	1	1	Low Power
X	1	0	High Power

2.4.4 ModPrsL

ModPrsL is grounded in the module. The ModPrsL is asserted “Low” when inserted and deasserted “High” when the module is physically absent from the host connector.

2.4.5 IntL

IntL is an output pin, when “Low”, it indicates a possible module operational fault or a status critical to the host system. The host identifies the source of the interrupt using the 2-wire serial interface. The IntL pin is an open collector output and must be pulled to host supply voltage on the host board.

For testing purpose IntL can be set via register write to address 147 of memory page 2, by writing 1 to this address the IntL hardware signal will be set high, writing 0 to address 147 will reset IntL to low.

2.5 QSFP Memory Map

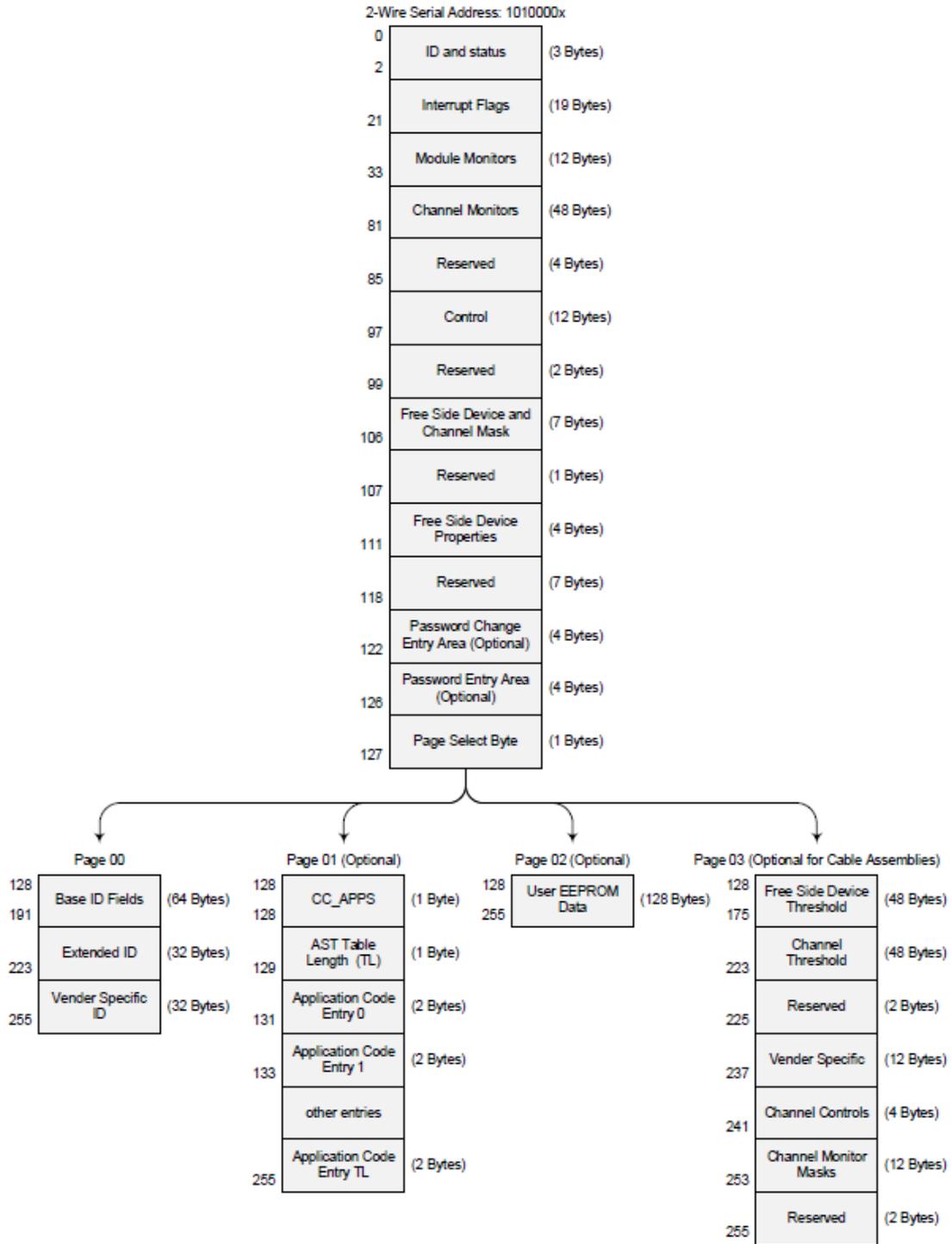


Figure 5: QSFP+ Memory Map

This section defines the Memory Map for QSFP transceiver used for serial ID, digital monitoring and certain control functions. The interface is mandatory for all QSFP devices.

The structure of the memory is shown in Figure 5. The memory space is arranged into a lower, single page, address space of 128 bytes and multiple upper address space pages. This structure permits timely access to addresses in the lower page, e.g. Interrupt Flags and Monitors. Less time critical entries, e.g. serial ID information and threshold settings are available with the Page Select function. The structure also provides address expansion by adding additional upper pages as needed. For example, in Figure 5 upper pages 01 and 02 are optional. Upper page 01 allows implementation of Application Select Table, and upper page 02 provides user read/write space. The lower page and upper pages 00 and 03 are always implemented.

2.5.1 Lower Memory Map

The lower 128 bytes of the 2-wire serial bus address space, see Table 6, is used to access a variety of measurements and diagnostic functions, a set of control functions, and a means to select which of the various upper memory map pages are accessed on subsequent reads. This portion of the address space is always directly addressable and thus is chosen for monitoring and control functions that may need to be repeatedly accessed. The definition of Identifier field is the same as page 00h Byte 128.

Byte Address	Description	Type
0	Identifier (1 Byte)	Read-Only
1-2	Status (2 Bytes)	Read-Only
3-21	Interrupt Flags (19 Bytes)	Read-Only
22-33	Module Monitors (12 Bytes)	Read-Only
34-81	Channel Monitors (48 Bytes)	Read-Only
82-85	Reserved (4 Bytes)	Read-Only
86-97	Control (12 Bytes)	Read/Write
98-99	Reserved (2 Bytes)	Read/Write
100-106	Module and Channel Masks (7 Bytes)	Read/Write
107-118	Reserved (12 Bytes)	Read/Write
119-122	Password Change Entry Area (optional) (4 Bytes)	Read/Write
123-126	Password Entry Area (optional) (4 Bytes)	Read/Write
127	Page Select Byte	Read/Write

2.6 ML4002-56 Specific Functions

2.6.1 Temperature Monitor

The **ML4002-56** has an internal temperature sensor in order to continuously monitor the module temperature. The temperature sensor readings are present in low-memory registers 22-23 as specified by QSFP SFF. Internally measured Module temperature are represented as a 16-bit signed two's complement value in increments of 1/256 degrees Celsius, yielding a total range of -127°C to $+128^{\circ}\text{C}$ that is considered valid between -40 and $+125^{\circ}\text{C}$. Temperature accuracy is vendor specific but must be better than ± 3 degrees Celsius over specified operating temperature and voltage. Please see vendor specification for details on location of temperature sensor.

Address	Bit	Name	Description
22	ALL	Temperature MSB	Internally measured module temperature
23	ALL	Temperature LSB	Internally measured module temperature

2.6.2 Insertion Counter

The Insertion counter contains the number of times the module was plugged in a host. The insertion counter is incremented every time the module goes in initializing sequence, as it is nonvolatile it is always saved, and can be read anytime from registers 141 and 142 on memory page 2.

Address	Bit	Name	Description
141	LSB	Insertion Counter LSB	LSB unit = 1 insertion
142	MSB	Insertion Counter MSB	

2.6.3 Programmable Power Dissipation & Thermal Emulation

Register 98 is used for PWM control over I2C. It is an 8-bit data wide register.

The consumed power changes when the value in this register is changed (only when in high power mode). In Low power mode the module automatically turns off PWM.

The values written in this register are permanently stored. The PWM can be used for module thermal emulation.

The module contains 3 thermal spots positioned where the optical transceivers usually are in an optical module that is heated relative to the PWM register. The first spot is 2.5 W and the second is 1.5 W. These can be turned either on or off allowing a power consumption of 0 or 100% of the overall power. A third spot of 1 W can be controlled using PWM, thus allowing a power consumption that covers all the range from 0 to 1 W with a 15 mW precision.

Address	Bit	Name	Description
98	0:5	1 W PWM controller	Power consumption varies linearly with the value set. Bits[5:0] val = 0 to 63 corresponds to 0 to 1 W power consumption.
98	6	1.5 W static power spot controller	Bit 6 = 0: Adds 0 W to the power consumption Bit 6 = 1: Adds 1.5 W to the power consumption
98	7	2.5 W static power spot controller	Bit 7 = 0: Adds 0 W to the power consumption Bit 7 = 1: Adds 2.5 W to the power consumption

2.6.4 Cut-Off Temperature

To avoid overheating the module, a Cut-Off Temperature is pre-defined.

The module is continuously monitoring the temperature and checking its value against the Cut-Off temperature. Once the module temperature reaches the cut-off temperature, the PWM will automatically turn off in order to prevent overheating. Once the temperature is 5 degrees below cut-off value, the PWM goes back to its previous value.

The Cut-Off temperature for the **ML4002-56** is 80°C.

2.6.5 Power Staging

In order to limit the module inrush current, the firmware drives PWM transitionally through multiple stages; each stage enables 5% of the overall power, a programmable delay separates each stage from the next.

The user can set the programmable delay from register 143 and 144 from page 02.

After the delay value is changed, a module reset is required so that the new delay value becomes effective.

Address	Bit	Name	Description
143	LSB	Programmable delay LSB	LSB unit = 1 μ s
144	MSB	Programmable delay MSB	

2.6.6 Voltage Sense

A voltage sense circuit is available in the **ML4002-56** that allows to measure the internal module supplied voltage Vcc. Measured values range from 0 to 6528 mV with a 0.1 mV precision.

Address	Bit	Name	Description
26	ALL	Supply Voltage MSB	Internally measured module supply voltage LSB= 0.1 mV
27	ALL	Supply Voltage LSB	

2.6.7 Low speed control signals pin state

Name	Address	Bit	Description
ResetL	145	0	1 if ResetL is High (145=0xFF if ResetL is Low)
LPMMode	146	0	1 if LPMMode is High and 0 if Low
IntL	147	0	1 if IntL is High and 0 if Low

All these registers are accessible from memory page 2.

3. QSFP56 Pin Allocation

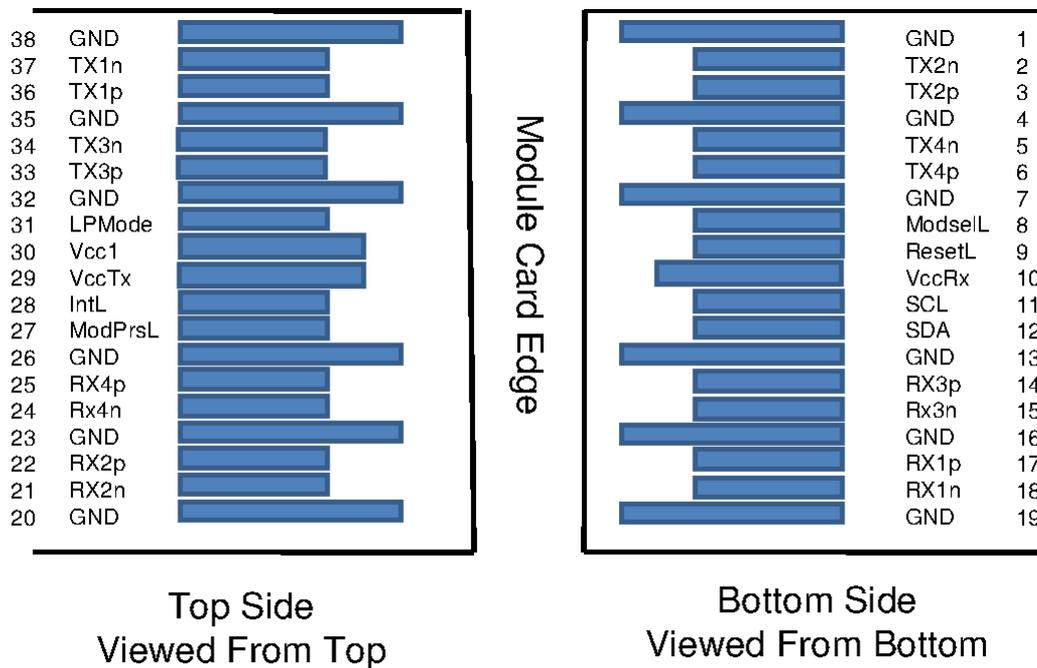


Figure 6: QSFP+ Module Pin Map

Pin#	Pin name	Logic	Description
1	GND		Power Ground
2	Tx2n	CML-I	Transmitter Inverted Data Input
3	Tx2p	CML-I	Transmitter Non-Inverted Data Input
4	GND		Power Ground
5	Tx4n	CML-I	Transmitter Inverted Data Input
6	Tx4p	CML-I	Transmitter Non-Inverted Data Input
7	GND		Power Ground
8	ModSelL	LVTTTL I	Module Select
9	ResetL	LVTTTL I	Module Reset
10	Vcc Rx		+3.3 V Power supply receiver
11	SCL	LVC MOS – I/O	2-wire serial interface clock
12	SDA	LVC MOS – I/O	2-wire serial interface data
13	GND		Power Ground
14	Rx3p	CML-O	Receiver Non-Inverted Data Output
15	Rx3n	CML-O	Receiver Inverted Data Output
16	GND		Power Ground
17	Rx1p	CML-O	Receiver Non-Inverted Data Output
18	Rx1n	CML-O	Receiver Inverted Data Output
19	GND		Power Ground
20	GND		Power Ground
21	Rx2n	CML-O	Receiver Inverted Data Output
22	Rx2p	CML-O	Receiver Non-Inverted Data Output
23	GND		Power Ground
24	Rx4n	CML-O	Receiver Inverted Data Output
25	Rx4p	CML-O	Receiver Non-Inverted Data Output
26	GND		Power Ground
27	ModPrsl	LVTTTL O	Module Present
28	IntL	LVTTTL O	Interrupt
29	Vcc Tx		+3.3 V Power supply transmitter
30	Vcc1		+3.3 V Power Supply
31	LPMMode	LVTTTL I	Low Power Mode
32	GND		Power Ground
33	Tx3p	CML-I	Transmitter Non-Inverted Data Input
34	Tx3n	CML-I	Transmitter Inverted Data Input
35	GND		Power Ground
36	Tx1p	CML-I	Transmitter Non-Inverted Data Input
37	Tx1n	CML-I	Transmitter Inverted Data Input
38	GND		Power Ground

4. High Speed Signals

High speed signals are electrically lopped back from TX side to RX side of the module, all differential TX pairs are connected to the corresponding RX pairs, and the signals are AC coupled as specified by QSFP MSA High Speed Electrical specs.

The Passive traces connecting TX to RX pairs are designed to support a data rate up to 56 Gbps. Trace width is 15 mils and 12 mils gap for differential pair with Rogers 4350 PCB material.

4.1 Trace Length

Net Name	Etch Length (mils)
RX1N	821.84
RX1P	864.26
RX2N	819.72
RX2P	862.14
RX3N	508.64
RX3P	550.98
RX4N	506.53
RX4P	548.76
TX1N	920.94
TX1P	878.52
TX2N	964.92
TX2P	922.5
TX3N	613.52
TX3P	571.09
TX4N	578.28
TX4P	535.86

Revision History

Revision number	Date	Description
0.1	09/30/2019	▪ Preliminary
0.2	08/31/2020	▪ Format adjustments

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